

**Product Summary (@ T<sub>A</sub> = +25°C)**

V <sub>RRM</sub> (V)	I <sub>O</sub> (A)	V <sub>F(MAX)</sub> (V)	I <sub>R(MAX)</sub> (mA)
40	3	0.53	0.4

**Description and Applications**

The SBR3A40SAF is a single rectifier packaged in the low profile SMAF package. Providing low VF and excellent high temperature stability this device is ideal for use in general rectification applications such as:

- Boost Diode
- Blocking Diode
- Recirculating Diode

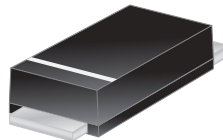
**Features and Benefits**

- Patented SBR technology provides an avalanche capability five times larger than Schottky diodes, ensuring more rugged and reliable end applications.
- Lower reverse leakage ensuring greater stability at higher temperatures
- Low forward voltage (V<sub>F</sub>) minimizes conduction losses and improving efficiency.
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

**Mechanical Data**

- Case: SMAF
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 Ⓜ
- Polarity: Cathode Band
- Weight: 0.064 grams (approximate)

SMAF



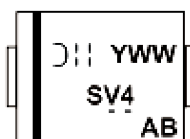
Top View

**Ordering Information (Note 4)**

Part Number	Case	Packaging
SBR3A40SAF-13	SMAF	10000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

**Marking Information**



SV4 = Product Type Marking Code  
 Ⓜ = Manufacturers' code marking  
 YWW = Date Code Marking  
 Y = Last digit of year (ex: 7 for 2007)  
 WW = Week code (01 to 53)  
 AB = Foundry and Assembly Code

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	40	V
Working Peak Reverse Voltage	V <sub>RWM</sub>		
DC Blocking Voltage	V <sub>RM</sub>		
Average Rectified Output Current (See Figure 1)	I <sub>O</sub>	3.0	A
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	50	A

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance Junction to Case (Note 5)	R <sub>θJC</sub>	15	°C/W
Thermal Resistance Junction to Ambient (Note 5)	R <sub>θJA</sub>	85	
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V <sub>F</sub>	—	0.46	0.53	V	I <sub>F</sub> = 3.0A, T <sub>J</sub> = +25°C
Leakage Current (Note 6)	I <sub>R</sub>	—	—	0.4	mA	V <sub>R</sub> = 40V, T <sub>J</sub> = +25°C
		—	—	80	mA	V <sub>R</sub> = 40V, T <sub>J</sub> = +125°C

Notes: 5. Device mounted on FR-4 substate, 1\*\*1", 2oz, single-sided, PC boards with 0.1\*\*0.15" copper pad.  
6. Short duration pulse test used to minimize self-heating effect.

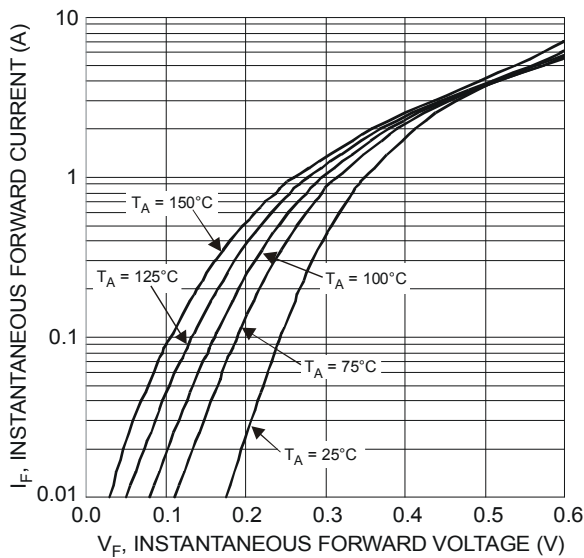


Figure 1 Typical Forward Characteristics

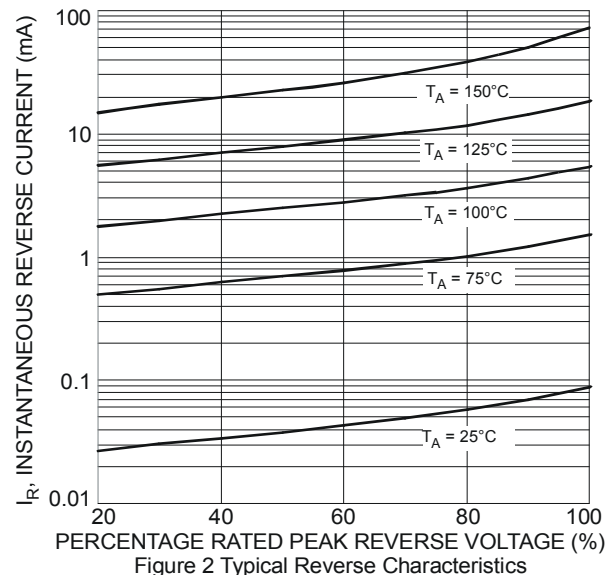


Figure 2 Typical Reverse Characteristics

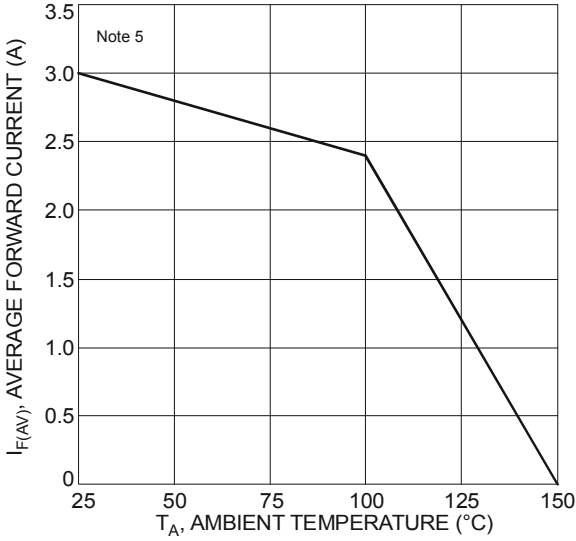


Figure 3 Forward Current Derating Curve

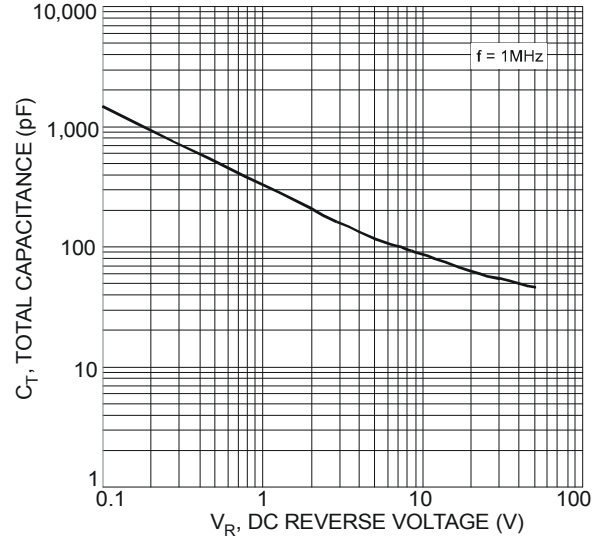
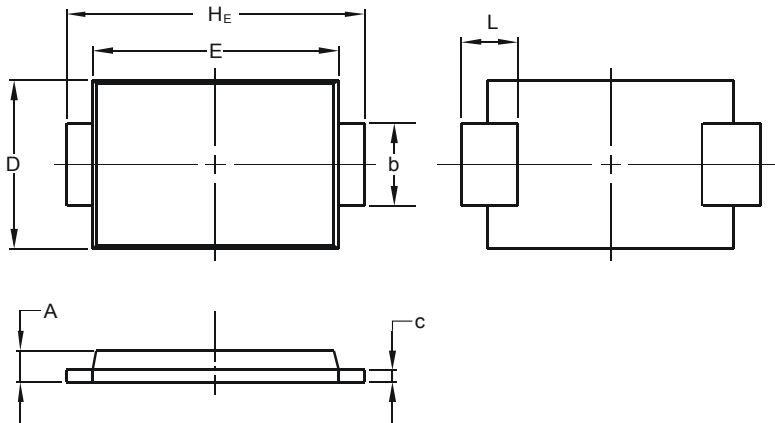


Figure 4 Total Capacitance vs. Reverse Voltage

### Package Outline Dimensions

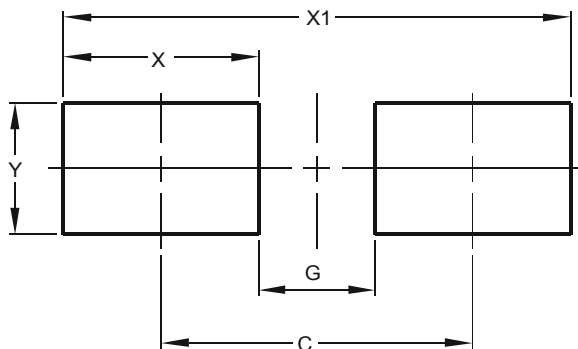
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SMAF		
Dim	Min	Max
A	0.90	1.10
b	1.25	1.65
c	0.10	0.40
D	2.25	2.95
E	3.95	4.60
H <sub>E</sub>	4.80	5.60
L	0.50	1.50
All Dimensions in mm		

### Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	4.00
G	1.50
X	2.50
X1	6.50
Y	1.70

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